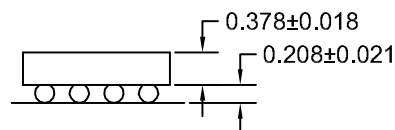
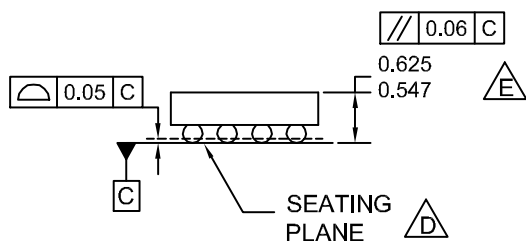
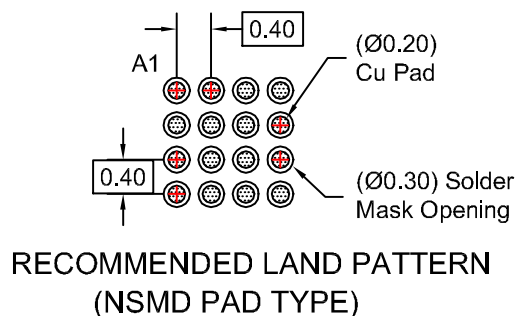
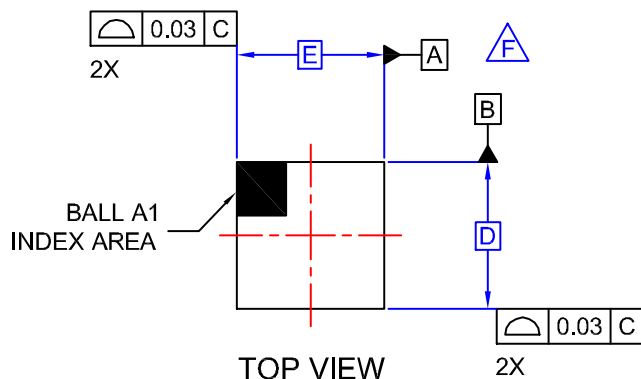


WLCSP16 1.61x1.61x0.586

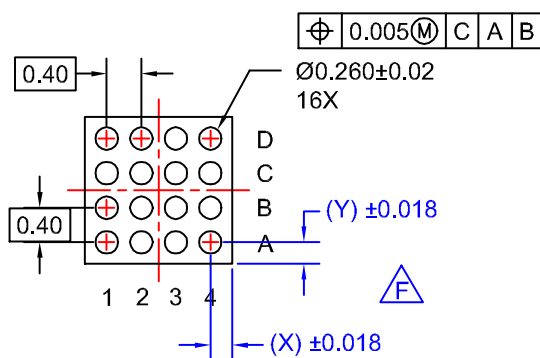
CASE 567SB

ISSUE O

DATE 30 NOV 2016






SIDE VIEWS



BOTTOM VIEW

NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASME Y14.5M, 1994.
-  DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
-  PACKAGE NOMINAL HEIGHT IS 586 MICRONS ± 39 MICRONS (547-625 MICRONS).
-  FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP16 1.61x1.61x0.586	PAGE 1 OF 1

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